

### NOTES:

MECHANICAL REQUIREMENTS:

Durability: 20'000 cycles at Hnom (nominal height)
Working stroke between H1 and H2: S= 1.2 mm [.047']
Spring forces (F):
Finit= 0.5 N at Hinit= 9.05 mm [.356']
F1= 0.57 N at H1= 8.85 mm [.348']
Fnom= 0.82±0.15 N at Hnom= 8.25 mm [.324']

F1= 0.5/ N at H1= 8.85 mm (.348")
Fnom= 0.82±0.15 N at Hnom= 8.25 mm (.324")
F2= 1.0 N at H2= 7.65 mm (.301")
Recommended working range: between H1 and H2

Forces are measured in mean value of compression / decompression

# ELECTRICAL REQUIREMENTS:

Contact resistance:

R= 30 m0hms max in static mode at Hnom

Current per individual contact in free air at ambient temperature:

| ICont= 5 A at Hnom with temperature raise max 30°C

# ELECTRICAL REQUIREMENTS:

Contact resistance:

R= 30 mOhms max in static mode at Hnom

Current per individual contact in free air at ambient temperature:

ICont= 5 A at Hnom with temperature raise max 30°C

#### ENVIRONMENTAL REQUIREMENTS:

Operating temperature: -25 °C / +125 °C Storage temperature: -40 °C / +125 °C

Relative humidity: 5% / 95%

## MATERIALS / PLATINGS:

Contact interfaces plated with 0.5 µm [20µ'] gold over Nickel Spring: Stainless steel

Clip : Beryllium Copper

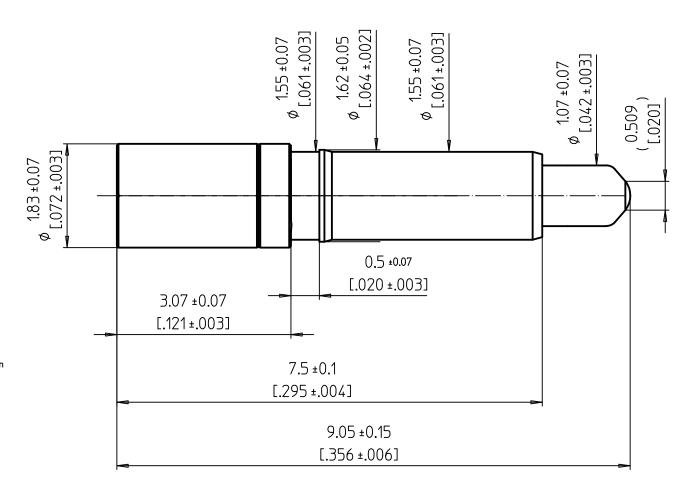
### SOLDERING:

Recommanded PCB pad size : 2.0 mm [.078']

Solderability J-STD-002A. Test A 245°C, 5s, solder alloy SnAg3.8Cu0.7 Resistance to soldering heat J-STD-020C, 260°C, 20S

## INSULATOR:

If assembling pin into mouliding:
Recommanded hole size: 01.58[.062']



		90647-AS//0907-5-CLIP		
High Realibility		Remplacé par:		
Spring Loaded Contact	15:1	Dessiné	10.11.2020	C.Bidault
		Contrôlé		
m proci din	N° dessin			Révision
preci-dip swiss world connect	0907-5-CLIP			P2